

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		250	V
V _{GS}	Gate to Source Voltage		±20	V
	Drain Current -Continuous	(Note 1a)	3.0	•
D	-Pulsed		50	— A
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	12.5	mJ
Р	Power dissipation	(Note 1a)	2.5	w
P _D	Power dissipation	(Note 1b)	1.0	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to 150	°C

Thermal Characteristics

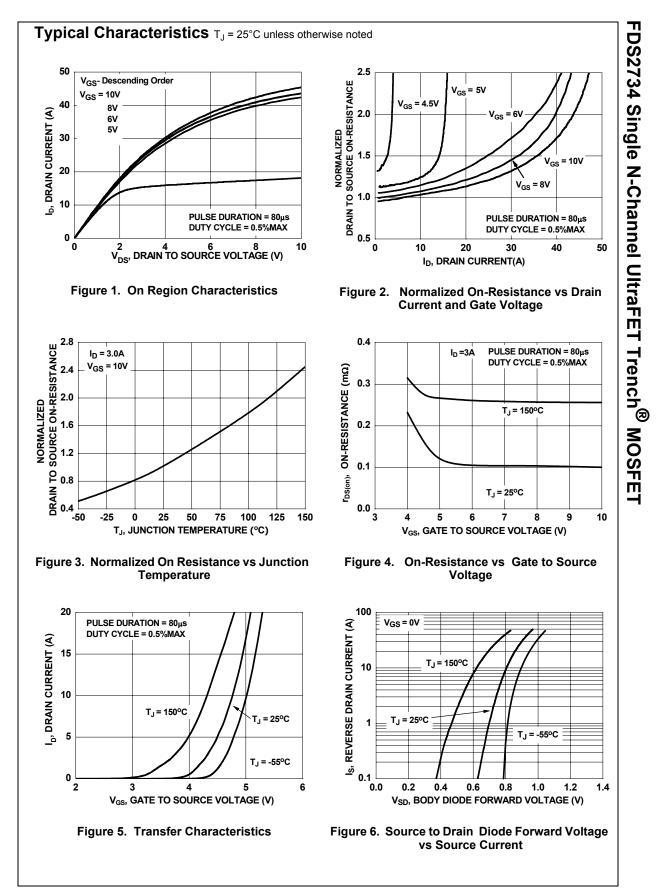
R_{\thetaJA}	Thermal Resistance, Junction- to -Ambient	(Note 1a)	50	
$R_{\theta JA}$	Thermal Resistance, Junction- to- Ambient	(Note 1b)	125	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction -to- Case	(Note 1)	25	

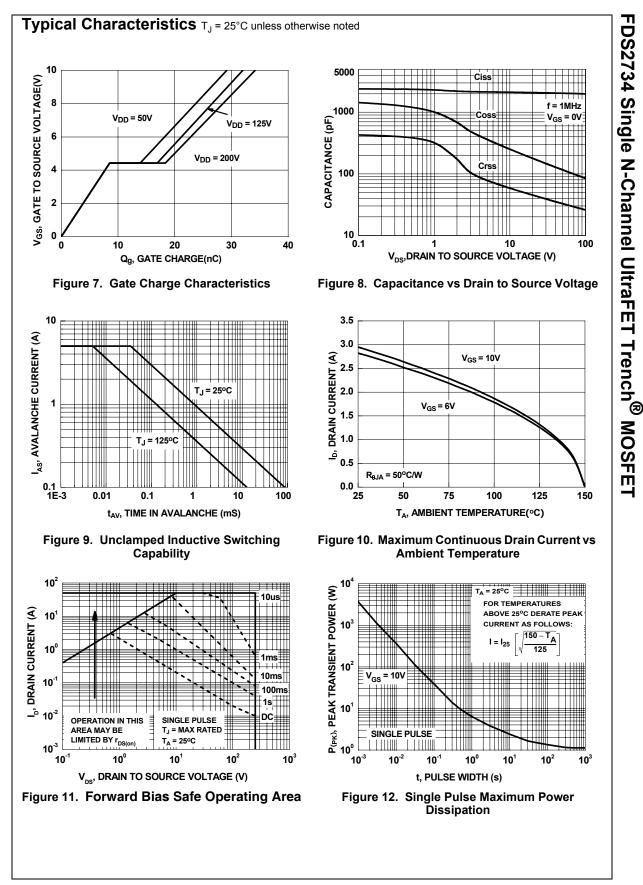
Package Marking and Ordering Information

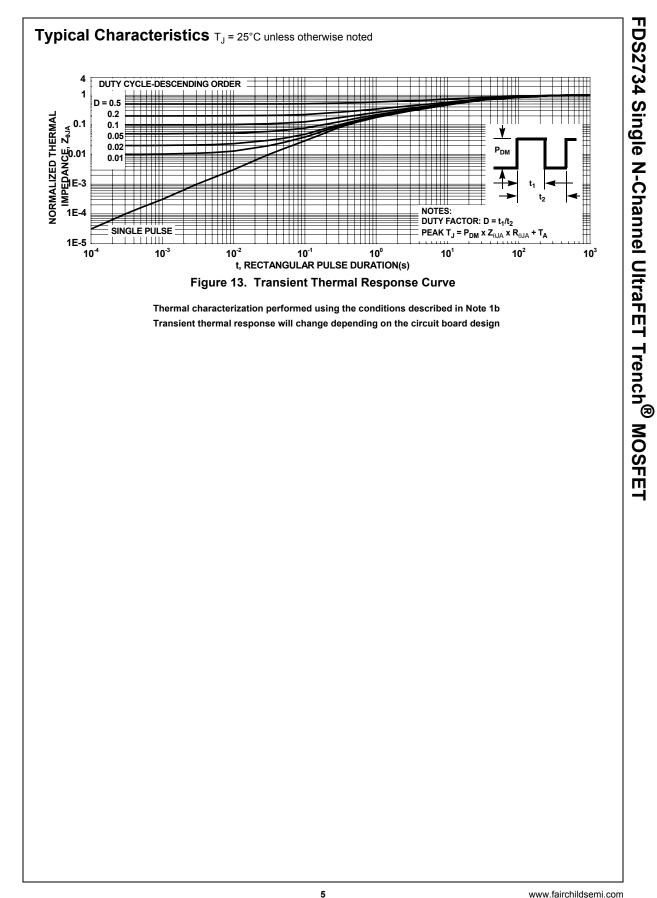
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS2734	FDS2734	SO-8	13"	12mm	2500 units

Off Charac BV _{DSS} ∆BV _{DSS}	Parameter	Test Conditions	Min	Тур	Max	Units
BV _{DSS}	teristics					
∆BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	250			V
ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25° C		157		mV/ºC
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 200V, V_{GS} = 0 V$ $V_{DS} = 200V, V_{GS} = 0V$ $T_{J} = 55^{\circ}C$			1 10	μΑ
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V, V _{DS} =0 V			±100	nA
On Charac	teristics (Note 2)			•		
	, <i>,</i>		2	2	4	V
$V_{GS(th)}$ $\Delta V_{GS(th)}$	Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$ $I_D = 250\mu A$, referenced to $25^{\circ}C$	2	3 -10.7	4	V mV/ ^c
ΔTJ	Temperature Coefficient	V _{GS} = 10V, I _D = 3.0A,		97	117	
(DC(cr))	Drain to Source On Resistance	$V_{GS} = 10V, I_D = 3.0A,$ $V_{GS} = 6V, I_D = 2.8A,$		101	126	mΩ
r _{DS(on)}		$V_{GS} = 10V, I_D = 3.0A, T_J = 125^{\circ}C$		205	225	
9 _{FS}	Forward Transconductance	$V_{\rm DS}$ =10V, I _D =3.0A,		15.1		s
	Characteristics			1	1	1
C _{iss}	Input Capacitance			1960	2610	pF
C _{oss}	Output Capacitance	$V_{DS} = 100V, V_{GS} = 0V,$		85	130	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		26	40	pF
R _G	Gate Resistance	f = 1MHz		0.7		Ω
t _{d(on)} t _r t _{d(off)} t _f	Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 125V, I_D = 3A$ $V_{GS} = 10V, R_{GS} = 6\Omega$		11 40 11	19 64 19	ns ns ns
Qg	Total Gate Charge	V _{DS} = 125V, V _{GS} = 10V		32	45	nC
Q _{gs}	Gate to Source Gate Charge	$I_D = 3.0A$		9		nC
Q _{gd}	Gate to Drain Charge			8		nC
	rce Diode Characteristics					
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 3.0A		0.74	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 3.0 A, d _{iF} /dt = 100A/μs		72	108	ns
Q _{rr}	Reverse Recovery Charge			185	278	nC

FDS2734 Single N-Channel UltraFET Trench[®] MOSFET







FDS2734 Rev. B

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